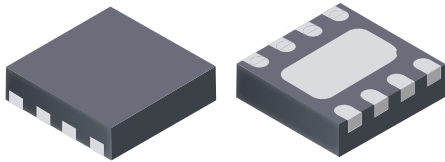


## Dual Half Bridge Motor Driver

### FEATURES AND BENEFITS

- Low  $R_{DS(on)}$  outputs
- Standby mode with zero current drain
- Small  $2 \times 2$  DFN package
- Crossover Current protection
- Thermal Shutdown protection

**PACKAGE: 8-contact DFN with Exposed Thermal Pad (suffix EE)**



*Not to scale*

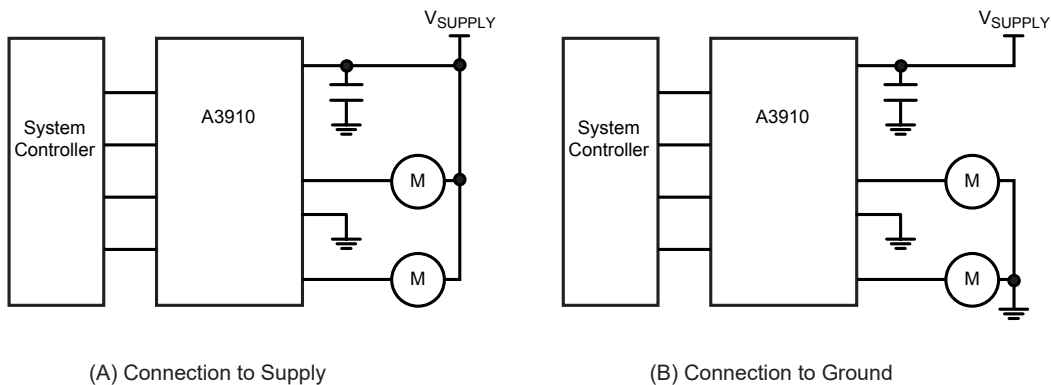
### DESCRIPTION

The A3910 is a dual half bridge motor driver, designed for low cost, low voltage battery operated power applications. The outputs are rated for operation up to 500 mA.

Direct control of high- and low-side drivers is implemented to allow either high-side or low-side PWM. The motor can be connected to either supply or GND. Using a MOS switch results in improved braking action for the motor, compared to implementation with simple clamp diode.

The A3910 is supplied in a  $2 \text{ mm} \times 2 \text{ mm}$  8-contact DFN package (EE) with exposed thermal pad. The package is lead (Pb) free, with 100% matte tin leadframe plating.

### Typical Application Diagram



## Selection Guide

Part Number	Packing*	Package
A3910EEETR-T	3000 pieces per 7-in. reel	8-contact DFN with exposed thermal pad

\*Contact Allegro™ for additional packing options.

## Absolute Maximum Ratings\*

Characteristic	Symbol	Notes	Rating	Unit
Supply Voltage	$V_{BB}$		-0.3 to 5.5	V
Logic Input Voltage Range	$V_{IN}$		-0.3 to 6	V
Output Current	$I_{OUT}$		500	mA
Output Voltage	$V_{OUT}$		-0.3 to $V_{BB} + 1$	V
Operating Ambient Temperature	$T_A$	E temperature range	-40 to 85	°C
Maximum Junction Temperature	$T_{J(max)}$		150	°C
Storage Temperature	$T_{stg}$		-55 to 150	°C

**Thermal Characteristics** may require derating at maximum conditions, see application information

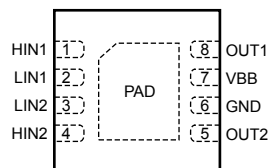
Characteristic	Symbol	Test Conditions*	Value	Unit
Package Thermal Resistance	$R_{\theta JA}$	On 4-layer PCB based on JEDEC standard	49	°C/W
		On 2-layer PCB based with 0.23 in. <sup>2</sup> exposed copper each side	92	°C/W

\*Additional thermal information available on the Allegro website.

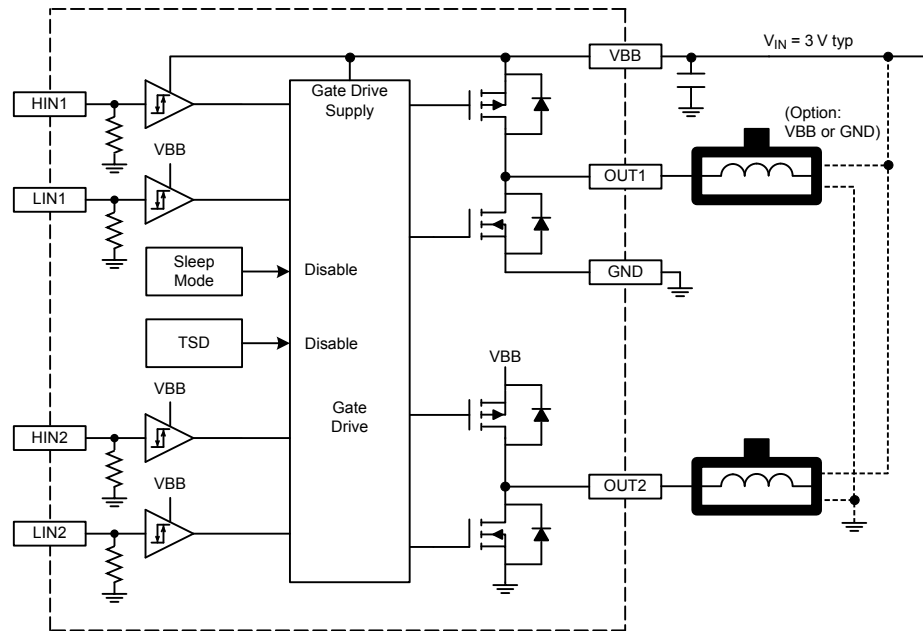
## Terminal List Table

Number	Name	Function
1	HIN1	Logic input
2	LIN1	Logic input
3	LIN2	Logic input
4	HIN2	Logic input
5	OUT2	Motor terminal
6	GND	Ground
7	VBB	Input Supply
8	OUT1	Motor terminal

## Pin-out Diagram



Functional Block Diagram



## ELECTRICAL CHARACTERISTICS\* Valid at $T_A = 25^\circ\text{C}$ ; unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
V <sub>BB</sub> Supply Range	V <sub>BB</sub>		2.5	–	5.5	V
V <sub>BB</sub> Supply Current	I <sub>BB</sub>	Both bridges, PWM = 50 kHz	–	0.3	1	mA
		Sleep mode (HIN1=HIN2=LIN1=LIN2=0V)	–	<1	1	μA
Output Driver On-Resistance	R <sub>DS(on)</sub>	Source driver, I = 400 mA, V <sub>BB</sub> = 3 V	–	1.1	1.4	Ω
		Source driver, I = 400 mA, V <sub>BB</sub> = 5 V	–	0.8	1	Ω
		Sink driver, I = 400 mA, V <sub>BB</sub> = 3 V	–	0.5	0.65	Ω
		Sink driver, I = 400 mA, V <sub>BB</sub> = 5 V	–	0.4	0.52	Ω
Input Logic Low Level	V <sub>IL</sub>		–	–	0.5	V
Input Logic High Level	V <sub>IH</sub>		V <sub>BB</sub> / 2	–	–	V
Input Hysteresis	V <sub>HYS</sub>		50	150	300	mV
Logic Input Current	I <sub>IN</sub>	V <sub>IN</sub> = 3.3 V (Pulldown = 100 kΩ)	–	33	50	μA
Thermal Shutdown Temperature	T <sub>JTSD</sub>	Temperature increasing	–	165	–	°C
Thermal Shutdown Hysteresis	ΔT <sub>J</sub>	Recovery = T <sub>JTSD</sub> – ΔT <sub>J</sub>	–	15	–	°C

\*Specified limits are tested at a single temperature and assured over operating temperature range by design and characterization.

## Logic Table

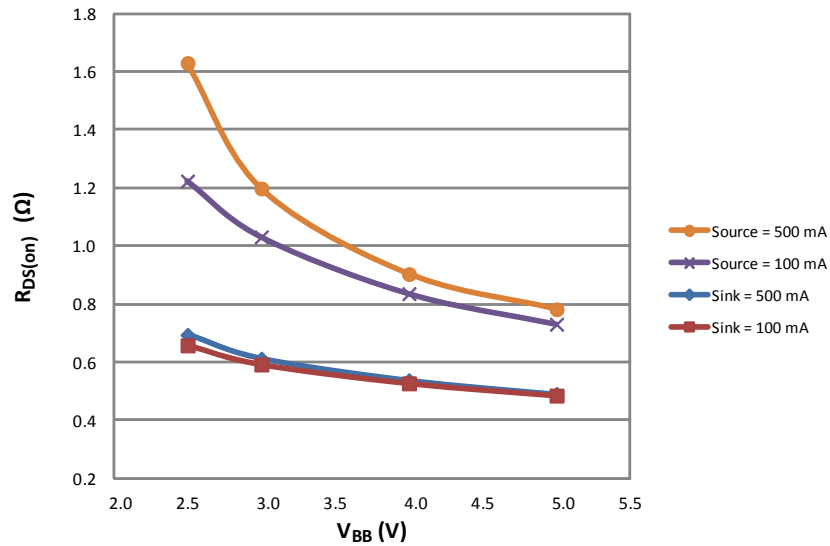
HINx	LINx	OUTx	Function Motor to Supply	Function Motor to GND
0	0	Hi-Z <sup>1</sup>	Coast (Sleep <sup>2</sup> )	Coast (Sleep <sup>2</sup> )
1	0	High	Brake	Drive
0	1	Low	Drive	Brake
1	1	Hi-Z <sup>1</sup>	Coast	Coast

<sup>1</sup>Hi-Z is high impedance.

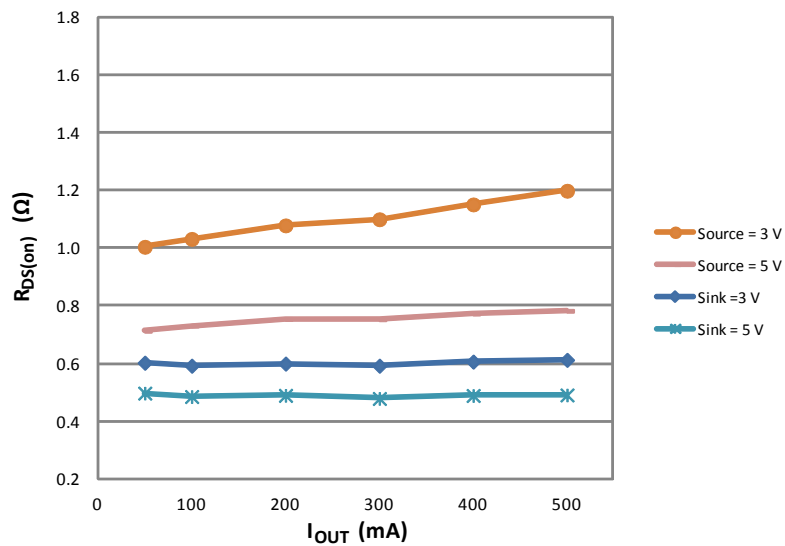
<sup>2</sup>Sleep mode activated by all four inputs <100 mV.

Characteristic Performance

Output On-Resistance versus Load Supply Voltage



Output On-Resistance versus Output Current



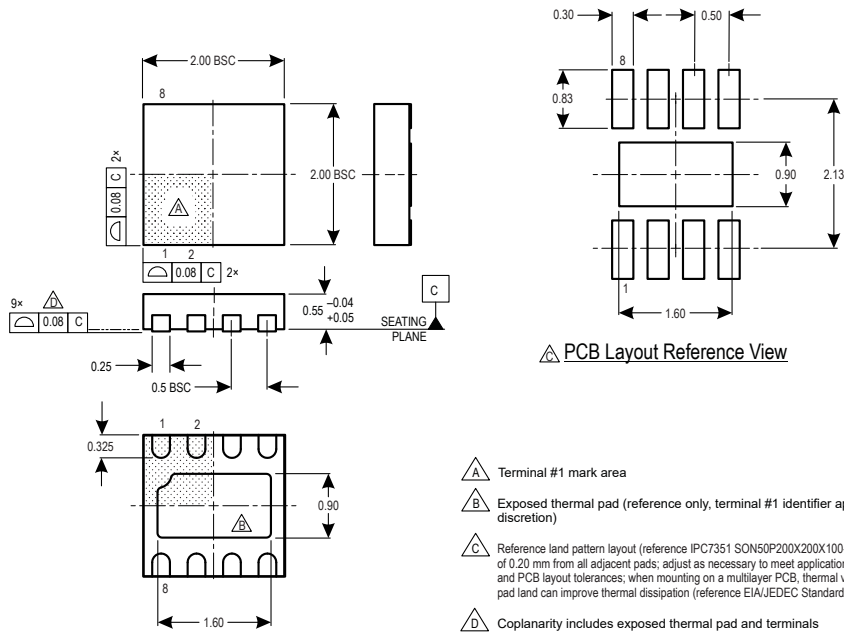
## Package EE, 8-Contact DFN with Exposed Thermal Pad

**For Reference Only – Not for Tooling Use**

(Reference DWG-0000369)

NOT TO SCALE

All dimensions nominal unless otherwise stated – Dimensions in millimeters  
Exact case and lead configuration at supplier discretion within limits shown



## Revision History

Number	Date	Description
1	July 23, 2013	Update Selection Guide
2	April 10, 2019	Minor editorial updates
3	April 30, 2021	Updated Package Outline Drawing (page 6)

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